

<b>PCN Number:</b>	20191009000A	<b>PCN Date:</b>	Oct. 15, 2019
<b>Title:</b>	Datasheet for LM76002, LM76003, and LM76002-Q1, LM76003-Q1		
<b>Customer Contact:</b>	PCN Manager	<b>Dept:</b>	Quality Services
<b>Change Type:</b>			
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Design
<input type="checkbox"/>	Assembly Process	<input checked="" type="checkbox"/>	Data Sheet
<input type="checkbox"/>	Assembly Materials	<input type="checkbox"/>	Part number change
<input type="checkbox"/>	Mechanical Specification	<input type="checkbox"/>	Test Site
<input type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Material
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Materials
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Process

### Notification Details

#### Description of Change:

Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.



**LM76002, LM76003**

SNVSAK0A – OCTOBER 2017 – REVISED OCTOBER 2019

#### Changes from Original (October 2018) to Revision A

**Page**

• Deleted "Operating" from "Junction temperature row" in <i>Abs Max</i> .....	5
• Deleted Operating junction temperature, $T_J$ , from ROC table .....	5
• Changed <a href="#">Figure 17</a> .....	18
• Updated <a href="#">Power Good and Overvoltage Protection (PGOOD)</a> section .....	20
• Updated Power Good description .....	20
• Updated title of component selection table .....	25



**LM76002-Q1, LM76003-Q1**

SNVSAU3B – DECEMBER 2017 – REVISED OCTOBER 2019

#### Changes from Original (December 2017) to Revision A

**Page**

• Deleted "Operating" from "Junction temperature row" in <i>Abs Max</i> .....	5
• Deleted Operating junction temperature, $T_J$ , from ROC table .....	5
• Updated Power Good description .....	20
• Updated title of component selection table .....	25

#### Changes from Revision A (November 2018) to Revision B

**Page**

• Updated the <a href="#">Thermal Information</a> table .....	6
• Changed <a href="#">Figure 17</a> .....	18
• Updated <a href="#">Power Good and Overvoltage Protection (PGOOD)</a> section .....	20

The datasheet number will be changing.

Device Family	Change From:	Change To:
LM76002, LM76003	SNVSAK0	SNVSAK0A
LM76002-Q1, LM76003-Q1	<b>SNVSAU3</b>	SNVSAU3B

These changes may be reviewed at the datasheet links provided.

<http://www.ti.com/product/LM76002>

<http://www.ti.com/product/LM76002-Q1>

**Reason for Change:**

To accurately reflect device characteristics.

**Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):**

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.

**Changes to product identification resulting from this PCN:**

None.

**Product Affected:**

LM76002RNPR	LM76002RNPT	LM76003RNPR	LM76003RNPT
LM76002QRNPRQ1	LM76002QRNPTQ1	LM76003QRNPRQ1	LM76003QRNPTQ1

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

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